

Surface Mount Schottky Barrier

FEATURES

- Very low profile - typical height of 0.68mm
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition



Micro SMA



MECHANICAL DATA

Case : Micro SMA

Molding compound, UL flammability classification rating 94V-0

Base P/N with suffix "G" on packing code - halogen-free, RoHS compliant

Base P/N with prefix "H" on packing code - AEC-Q101 qualified

Terminal : Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test,

with prefix "H" on packing code meet JESD 201 class 2 whisker test

Polarity : Indicated by cathode band

Weight : 0.006 gram (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)					
PARAMETER	SYMBOL	SS22M	SS23M	SS24M	UNIT
Marking code		D	E	F	
Maximum repetitive peak reverse voltage	V _{RRM}	20	30	40	V
Maximum average forward rectified current	I _{F(AV)}	2			A
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	25			A
Maximum instantaneous forward voltage (Note 1) @ 2.0A / T _A =25°C @ 2.0A / T _A =125°C	V _F	0.60 0.55			V
Maximum reverse current @ rated VR @ T _A =25 °C @ T _A =125 °C	I _R	150 15			uA mA
Typical junction capacitance (Note 2)	C _j	35			pF
Typical thermal resistance	R _{θJL} R _{θJC} R _{θJA}	15 20 105			°C/W
Operating junction temperature range	T _J	-55 to + 150			°C
Storage temperature range	T _{STG}	-55 to + 150			°C

Note 1 : Pulse test with PW=300u sec, 1% duty cycle

Note 2: Measured at 1 MHz and Applied Reverse Voltage of 4.0 V D.C.

ORDERING INFORMATION					
PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	PACKAGE	PACKING
SS2xM (Note 1)	Prefix "H"	RS	Suffix "G"	Micro SMA	1800 / 7" Plastic reel

Note 1: "x" defines voltage from 20V (SS22M) to 40V (SS24M)

EXAMPLE					
PREFERRED P/N	PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION
SS24M RSG	SS24M		RS	G	Green compound
SS24MHRS	SS24M	H	RS		AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

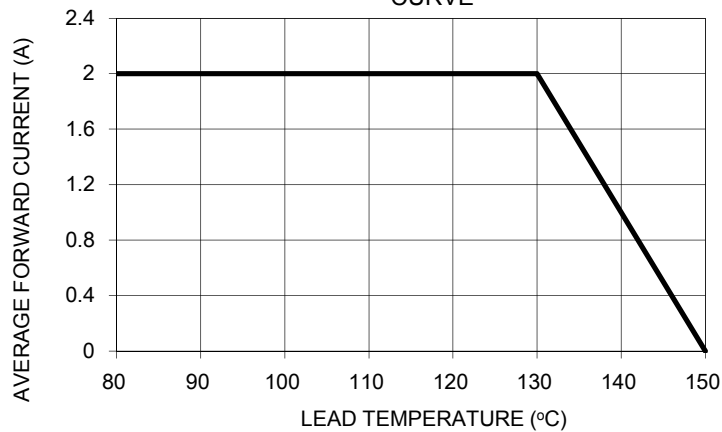


FIG. 2 MAXIMUM FORWARD SURGE CURRENT

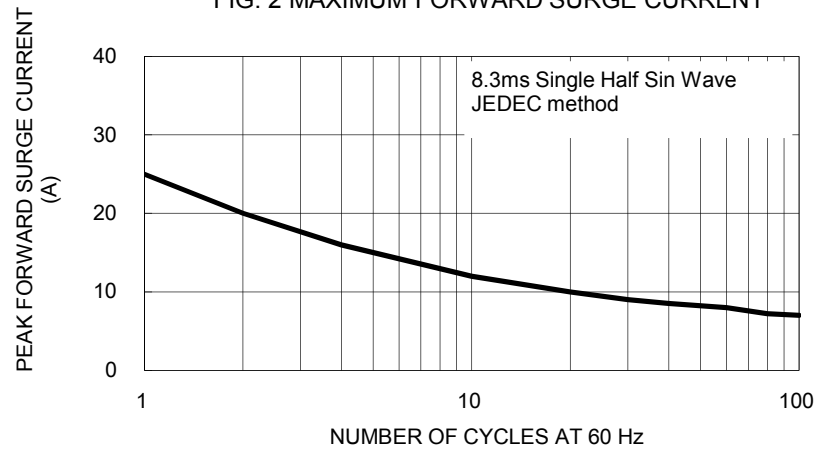


FIG. 3 TYPICAL FORWARD CHARACTERISTICS

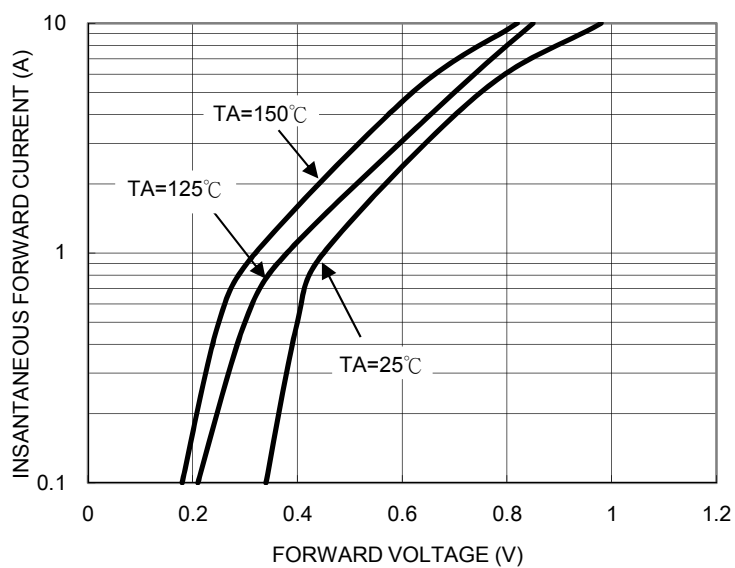


FIG. 4 TYPICAL REVERSE CHARACTERISTICS

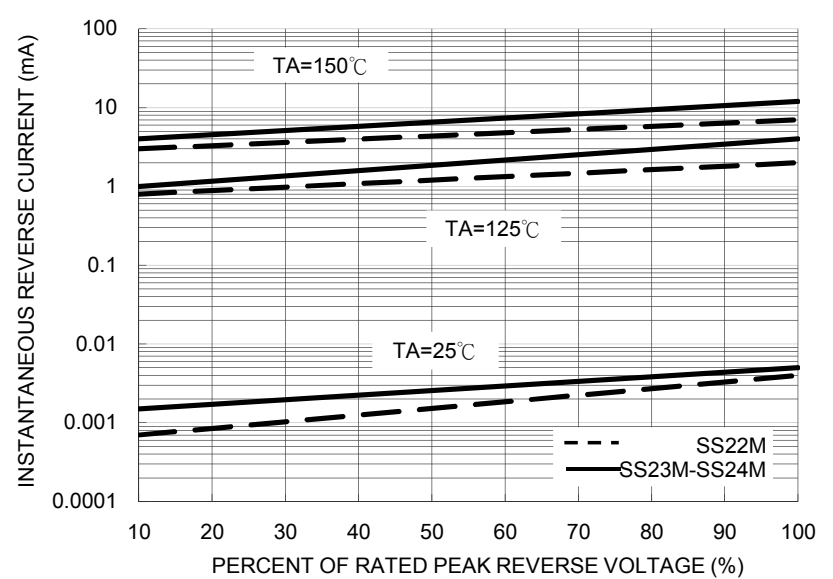


FIG. 5 TYPICAL JUNCTION CAPACITANCE

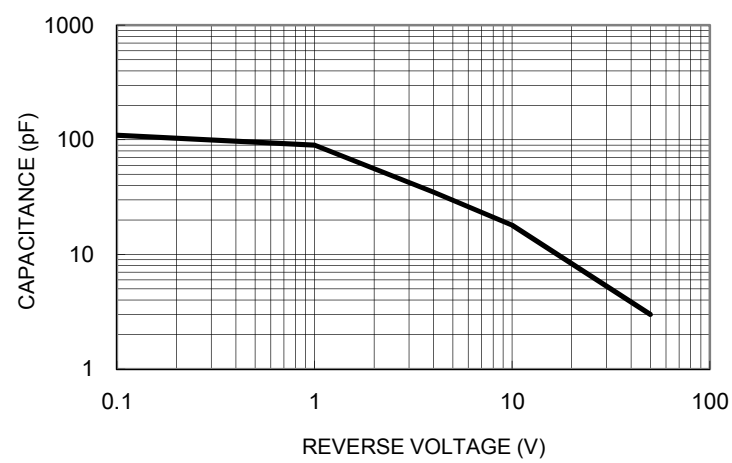
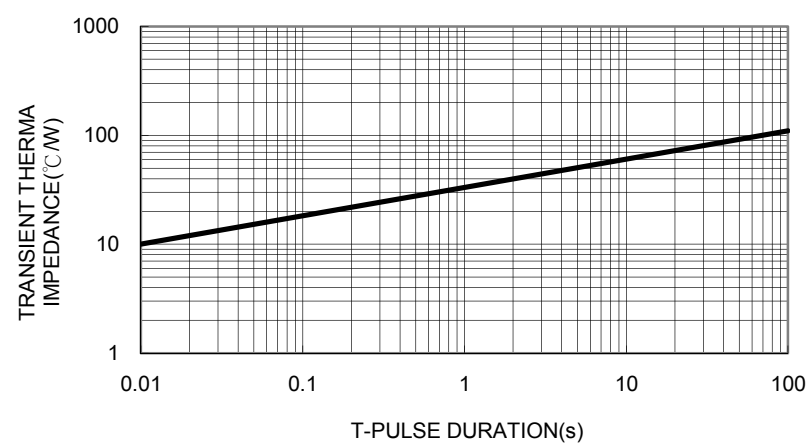
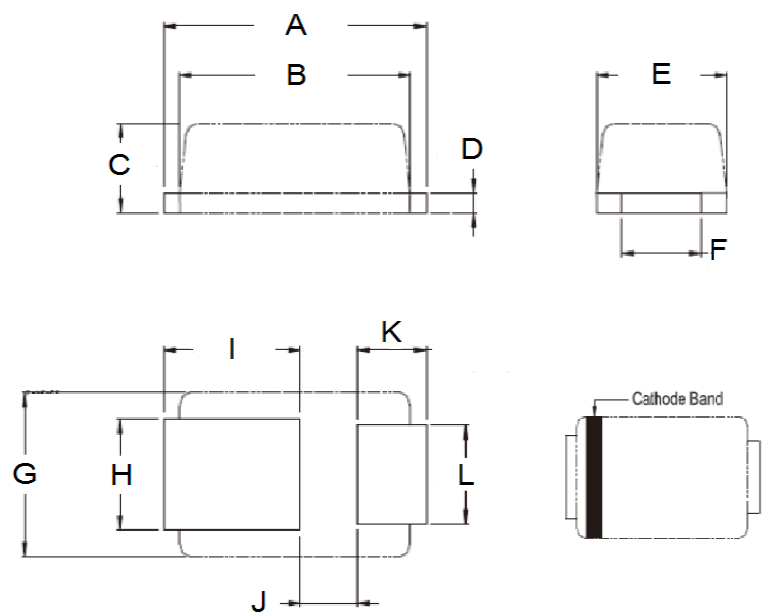


FIG. 6 TYPICAL TRANSIENT THERMAL IMPEDANCE

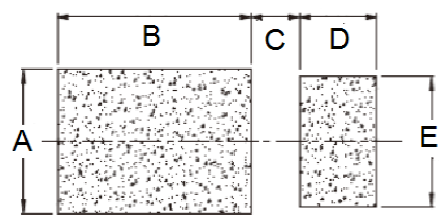


PACKAGE OUTLINE DIMENSIONS



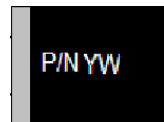
DIM.	Unit(mm)		Unit(inch)	
	Min	Max	Min	Max
A	2.30	2.70	0.091	0.106
B	2.10	2.30	0.083	0.091
C	0.63	0.73	0.025	0.029
D	0.10	0.20	0.004	0.008
E	1.15	1.35	0.045	0.053
F	0.65	0.85	0.026	0.034
G	1.15	1.35	0.045	0.053
H	0.75	0.95	0.030	0.037
I	1.10	1.50	0.043	0.059
J	0.55	0.75	0.022	0.030
K	0.55	0.75	0.022	0.030
L	0.65	0.85	0.026	0.034

SUGGESTED PAD LAYOUT



Symbol	Unit(mm)
A	1.1
B	2
C	0.5
D	0.8
E	1

MARKING DIAGRAM



P/N = Marking code
YW = Date Code

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